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AMENDMENTS TO THE CLAIMS

- (Currently Amended) A method of manufacturing a biological electrical stimulus cable assembly, comprising:
 - a) providing a cable portion, including a plurality of first conductive wires set into a length of insulative material having a surface, wherein the plurality of conductive wires are disposed at substantially the same radial depth within the insulative material;
 - b) removing a portion of said insulative material from said surface of said length of insulative material to <u>only</u> one of said conductive wires, thereby creating an exposed first wire surface;
 - c) electrically connecting a second conductive wire to said exposed first wire surface; and
 - d) placing a preformed conductive ring onto said cable portion and electrically connecting said second conductive wire to said conductive ring.
- (Original) The method of claim 1 wherein said second conductive wire is wrapped at least partially about said cable portion prior to being electrically connected to said conductive ring.
- (Original) The method of claim 2 wherein said conductive ring has a circumference and wherein said second conductive wire is joined to said conductive ring around a substantial portion of said circumference.
- (Currently Amended) The method of claim [[2]] 3 wherein said conductive wire is welded to said conductive ring around a substantial portion of said circumference.
- (Original) The method of claim 4 wherein said conductive wire is laser welded to said conductive ring around a substantial portion of said circumference.
- (Original) The method of claim 1 wherein said second conductive wire is welded to said first conductive wire.

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 (Original) The method of claim 6 wherein said second conductive wire is laser welded to said first conductive wire.

- (Original) The method of claim 1 wherein said second conductive wire is soldered to said first conductive wire.
- (Original) The method of claim 1 wherein said second conductive wire is welded to said conductive ring.
- (Original) The method of claim 9 wherein said second conductive wire is laser welded to said conductive ring.
- (Original) The method of claim 1 wherein said second conductive wire is soldered to said conductive ring.
- 12. (Currently Amended) The method of claim 1 wherein an additional portion of said insulative material is removed from said surface of said length of insulative material to <u>said</u> one of said conductive wires, thereby creating an additional exposed first wire surface at a location spaced apart from said exposed first wire surface and electrically connecting [[a]] <u>said</u> second conductive wire to said exposed first wire surface and said additional exposed first wire surface.
- 13. (Original) The method of claim 12 wherein said second wire is wrapped about said cable portion between said exposed first wire surface and said additional exposed first wire surface.
 - 14. (Cancelled)

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- 15. (Currently Amended) A method of manufacturing a biological electrical stimulus cable assembly, comprising:
 - a) providing a cable portion, including a plurality of first conductive wires set into a length of insulative material having a surface, wherein the plurality of conductive wires are disposed at substantially the same radial depth within the insulative material;
 - b) removing a portion of said insulative material from said surface of said length of insulative material to <u>only</u> a first one of said first conductive wires at a first location, thereby creating a first exposed first wire surface and removing a portion of said insulative material from said surface of said length of insulative material, also <u>only</u> to said first one of said first conductive wires at a second location, thereby creating a second exposed first wire surface;
 - c) electrically connecting a second conductive wire to said first exposed first wire surface; and
 - d) wrapping said second conductive wire about said cable portion and connecting it to said second exposed first wire surface, thereby creating a circumscribing electrode.